OKI Semiconductor

MSM9831-xxx

VOICE SYNTHESIS LSI with on-chip 384Kbit MASK ROM

GENERAL DESCRIPTION

MSM9831 is a PCM-based Voice Synthesis LSI (Playback only) with on-chip 384Kbit Mask ROM, D/A Converter and Low-Pass Filter.

Serial input interface for an external MCU makes MSM9831 a better choice for size-critical applications with less wiring pin-count in small foot-print packaging.

FEATURES

• 8-bit OKI Non-Linear PCM Algorithm

• Sampling Frequency (Selectable on each phrase) 4.0/5.3/6.4/8.0/10.6/12.8/16.0 kHz

• On-chip Mask ROM Capacity : 384 Kbits

Maximum Playback Time Length

12.0 sec. at fsam = 4.0 kHz 6.0 sec. at fsam = 8.0 kHz 3.0 sec. at fsam = 16.0 kHz

Clock Oscillation

3.5 to 4.5 MHz (Ceramic Oscillation) 3.5 to 17 MHz (External Clock)

5.5 to 17 WHIE (External Clock)

• User definable Phrase Control Table function

• Maximum number of Phrases : 31 phrases

• 10-bit current-output-type D/A Converter

• A built-in LPF

• Power Supply Voltage : +2.0 to +5.5 V (External Clock)

+2.5 to +5.5V (Ceramic Oscillation)

This version: Sep. 1999

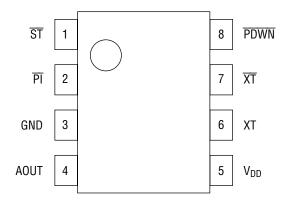
Package:

8-Pin SOP Package (SOP8-P-250-1.27-K) (Product name: MSM9831-xxx MA)

COMPARISON TABLE WITH MSM9802

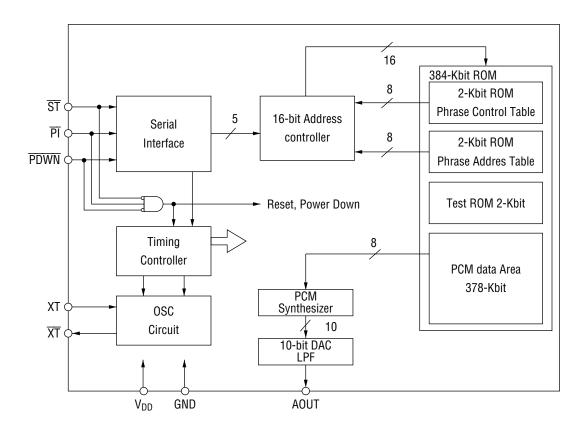
	MSM9831	MSM9802
Mask ROM Capacity	384K Bit	512K Bit
Interface	MCU (Serial)	MCU (Parallel)/Stand-alone
Oscillation	Ceramic/External Clock	Ceramic/CR
Max. Phrase Number	31	63
Status Signal Output	None	NAR/BUSY
D/A Converter Current Flowing	Forced into the circuit	Forced out of the circuit

PIN CONFIGURATION (TOP VIEW)



8-pin Plastic SOP

BLOCK DIAGRAM



PIN DESCRIPTIONS

Pin	Symbol	I/O	Description
1	ST	I	Playback starter pin.
			Phrase Address (number) is determined by the number of times of input to
			PI pin while ST being held "L". Playback starts on ST's rising edge with
			phrase address data loaded into the LSI. When no pulse input to $\overline{\text{Pl}}$ made
			while \overline{ST} being held "L", the LSI recognizes it as "Stop Code" to stop
			playback.
2	PΙ	I	Address input pin.
			The phrase number to playback is determined by the times of pulse pulse
			input to $\overline{\text{PI}}$ pin while $\overline{\text{ST}}$ being held "L".
			32-time pulse input has the internal counter initialized.
3	GND	_	GND pin.
4	AOUT	0	Analog output pin.
			Built with N-MOS open-drain type, wave-form output is made in the form of
			changing output current. While PDWN being held "H", AOUT maintains 1/2
			level output, thus the current keeps on flowing.
			The Pop-Noise Canceller is put into works when standby is reset to return to
			be active, and when entering into standby mode.
5	V _{DD}		Power supply pin. Insert a $0.1\mu F$ or larger by-pass capacitor in-between GND
			pin and this pin.
6	XT	I	Wired to the ceramic oscillator when a ceramic oscillator is in use.
			Input the clock signal to this pin when the external clock is selected as the
			timing source.
			Using a ceramic oscillator or an external clock can be selected with OKI's
			Analizing and Editing Tool.
7	XT	0	Wired to the ceramic oscillator when a ceramic oscillator is in use.
			When the external clock is in use, keep this pin open.
8	PDWN	I	The LSI remains in standby mode while this pin is being held "L".

ABSOLUTE MAXIMUM RATINGS

(GND=0V)

Parameter	Symbol	Condition	Rating	Unit
Power Supply Voltage	V_{DD}	Ta = 25°C	-0.3 to +7.0	V
Input Voltage	V _{IN}	1d = 20 G	-0.3 to V _{DD} +0.3	V
Storage Temperature	T _{STG}	_	−55 to +150	°C

RECOMMENDED OPERATING CONDITIONS

(GND=0V)

Parameter	Symbol	Condition	Range			Unit
		With a Ceramic Osc. (Note)		2.5 to 5.5		V
		With the external clock		2.0 to 5.5		V
		f _{OSC} =3.5 MHz to 4.5 MHz		2.0 10 5.5		V
Power Supply Voltage	V_{DD}	With the external clock		2.7 to 5.5		V
		f _{OSC} =3.5 MHz to 14.5 MHz		2.7 10 5.5		V
		With the external clock		3.0 to 5.5		V
		f _{OSC} =3.5 MHz to 17 MHz		0.0 10 0.0		
	fosc		Min.	Тур.	Max.	
		With a Ceramic Osc.	3.5	4.096	4.5	MHz
		V _{DD} =2.5 V to 5.5 V (Note)	0.0	4.030	7.0	IVII IZ
		With the external clock	3.5	4.096	4.5	MHz
Master Clock Frequency		V _{DD} =2.0 V to 5.5 V	0.0	4.030	4.5	IVIIIZ
		With the external clock	3.5		14.5	MHz
		V _{DD} =2.7 V to 5.5 V	3.3		14.5	IVIIIZ
		With the external clock	3.5		17	MHz
		V _{DD} =3.0 V to 5.5 V	0.0		17	IVIIIZ
Operating Temperature	T _{op}	_		–40 to +8	5	°C

Note: A crystal that is usable in this LSI is described in "Functional Description" of this document. If you want to use a different crystal, it is recommended to evaluate the crystal before using it.

ELECTRICAL CHARACTERISTICS

DC Characteristics

(V_{DD} =2.0 to 5.0 V, GND=0 V, f_{OSC} =4.096 MHz, T_a =-40 to +85°C, unless otherwise specified)

Parameter	Symbol		Con	ditic	on	Min.	Тур.	Max.	Unit
		f _{OSC} =14.5 MH	z or less	(V _D	_D =2.7 V to 5.5 V)	V_{DD}			V
"H" Input Voltage	V	f _{OSC} =4.5 MHz	or less	(V_D)	_D =2.0 V to 5.5 V)	× 0.8	_		V
n iliput voltage	V _{IH}	f _{0SC} >14.5 MH	Z	(V _D	_D =3.0 V to 5.5 V)	V _{DD}	_	_	V
					0.71/1 5.51/	× 0.85		.,	
		f _{OSC} =14.5 MH			_D =2.7 V to 5.5 V)	_	_	V_{DD}	V
"L" Input Voltage	V _{IL}	f _{OSC} =4.5 MHz	or less	(V _D	_D =2.0 V to 5.5 V)			× 0.2	
L input voltago	• 1	f _{OSC} >14.5 MHz (V _{DD} =3.0 V to 5.5 V)			_	_	V_{DD} $\times 0.15$	V	
"H" Input Current	l _{IH}	V _{IH} =V _{DD}				_	_	10	μΑ
"L" Input Current	I _{IL}	$V_{IL} = GND$				-10	_	_	μΑ
			V _{DD} =5.5	5 V	f _{OSC} =4.096 MHz	_	1.2	3.0	mA
			AOUT autaut	V _{DD} =3.0) V	f _{OSC} =4.096 MHz	l —	0.4	1.0
Dynamic Supply		AOUT output	V _{DD} =2.0) V	f _{0SC} =4.096 MHz	I —	0.2	0.7	mA
Current	I _{DD}	current is	V _{DD} =5.5	5 V	f _{OSC} =16 MHz	_	_	12.0	mA
		excluded	V _{DD} =3.0) V	f _{OSC} =16 MHz	_	_	4.0	mA
			V _{DD} =2.0) V	f _{OSC} =16 MHz	_	_	2.8	mA
Standby Supply			Ta=-40°C to +70°C				_	10	μΑ
Current	I _{DS}	Ta=-40°C to		C to	+85°C		_	50	μΑ
AOUT Output		At maximum	,	V _{DD} =2.0 V to 5.5 V			_	8.9	mA
AOUT Output Current	I _{AOUT}			V _{DD} =5.5 V			6.0	8.9	mA
Current		output current		V _{DD} =2.0 V			1.0	1.9	mA

AC Characteristics

(Oscillation Frequency at f_{OSC}=4.096 MHz, V_{DD}=2.0 to 5.0 V, GND=0 V, Ta=-40 to +85°C)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Master Clock duty cycle	f _{duty}	_	40	50	60	%
Time before RESET input after Power On	t _{RST}	_	10	_	_	μS
PDWN hold time after RESET input	t _{PDH}	_	10	_	_	μS
DA Converter shifting time (Pop-Noise Canceller working time) *1	t _{DAR} , t _{DAF}	_	60	64	68	ms
PDWN-ST setup time	t _{PDSS}	_	1	_	_	μs
ST-PI setup time	t _{SPS}	_	1	_	_	μs
PI pulse width	t _{PW}	_	0.35	_	2000	μs
PI cycle time	t _{PC}	_	0.7	_	4000	μs
ST-PI hold time	t _{SPH}	_	1	_	_	μs
ST-AOUT setup time *2	t _{SAS}	f _{SAM} =8.0 kHz	_	_	1050	μs
Phrase stop time *2	t _{DPS}	f _{SAM} =8.0 kHz	_		700	μs
Silence in-between phrases *2	t _{BLN}	f _{SAM} =8.0 kHz	_	_	700	μs
Stop ST pulse width	t _{SSW}	_	0.35	_	2000	μs
Phrase ST-Phrase ST pulse interval *2	t _{PP}	f _{SAM} =8.0 kHz	1050	_	_	μs
Phrase ST-Stop ST pulse interval *2	t _{PS}	f _{SAM} =8.0 kHz	1050	_	_	μs
Stop ST-Phrase ST pulse interval *2	t _{SP}	f _{SAM} =8.0 kHz	500	_	_	μs
Sampling Frequency *3	f _{SAM}	_	3.9	_	28.0	kHz

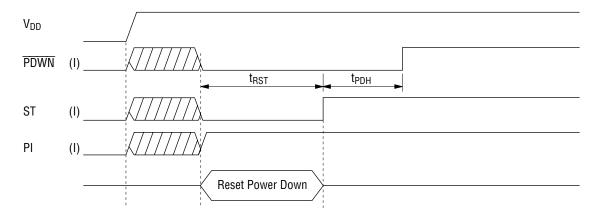
^{*1} Proportional to the period of oscillation frequency (f_{OSC}).

^{*2} Proportional to the period of sampling frequency (f_{SAM}).

^{*3} The sampling frequency (f_{SAM}) is determined by the oscillation frequency (f_{OSC}) and the frequency dividing ratio selected for each phrase.

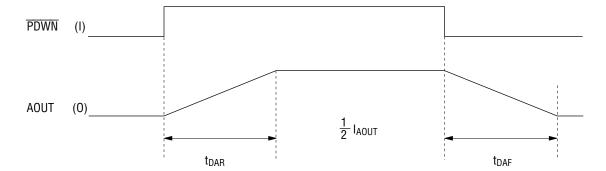
TIMING DIAGRAMS

1. Power-On

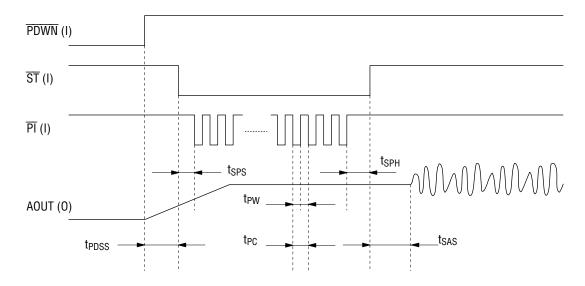


Note: A level input in combination of $\overline{PDWN}="L"$, $\overline{ST}="L"$ and $\overline{PI}="H"$ resets the LSI. After Power-On, you need to do an initial reset as shown in the above chart.

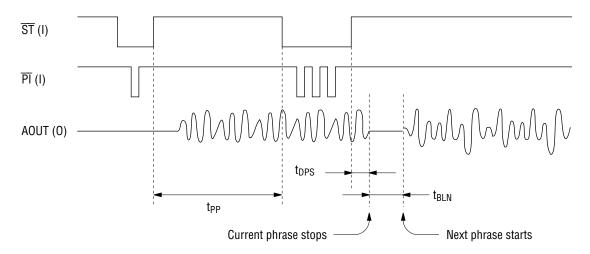
2. Activating the LSI and Standby Mode



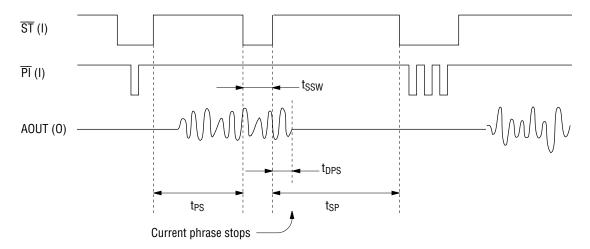
3. Playback



4. Re-inputting the address while playback is going on



5. Stop Code Input



FUNCTIONAL DESCRIPTION

1. Sampling Frequency

Sampling Frequency can be selected and setup on each phrase address. 7 sampling frequencies are available for user's choice in preparing Voice Data File at the pre-production stage. Select sampling frequencies to satisfy f_{SAM} =3.9 to 28.0 kHz obtained by frequency dividing ratios in Table 1.1.

Sampling Frequency	Frequency diving ratio
(f _{OSC} =4.096MHz)	Trequency diving ratio
4.0kHz	f _{0SC} /1024
5.3kHz	f _{OSC} /768
6.4kHz	f _{OSC} /640
8.0kHz	f _{OSC} /512
10.6kHz	f _{OSC} /384
12.8kHz	f _{0SC} /320
16.0kHz	fosc/256

Table 1.1 Sampling Frequency

2. Recording/Playback Time

Figure 2.1 below shows memory allocation of on-chip 384K bit Mask ROM. The Mask ROM is partitioned into 4 data areas: user's Area, Phrase Control Table Area, Phrase Control Area and Test Data Area. Actual memory space is the total Mask ROM capacity (384K bit) indicated in this document minus 6K bit.

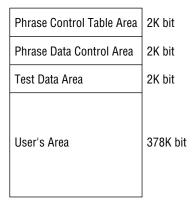


Figure 2.1 Memory Allocation of on-chip Mask ROM (384K bit)

The playback time is obtained by dividing the memory capacity by the bit rate. The playback time for 8-bit PCM algorithm is obrained by using the following equation.

Playback time [sec] =
$$\frac{\text{Memory capacity [bit]}}{\text{Bit rate [bps]}} = \frac{\text{Memory capacity [bit]}}{\text{Sampling frequency [Hz]} \times 8 \text{ [bit]}}$$

For example, if all phrases are stored in the MSM9802 at 8 kHz sampling frequency, the maximum playback time is as follows.

Playback time =
$$\frac{(384-6) \times 1024 \text{ [bit]}}{8000 \text{ [Hz]} \times 8 \text{ [bit]}} = 6.0 \text{ [sec]}$$

3. Playback Method

The MSM9831 uses OKI non-linear PCM algorithm. In the mid-range of waveform, OKI 8-bit non-linear PCM has precision equivalent to that of 10-bit straight PCM.

4. Inserting Silence

In addition to normal recorded sound phrases, the MSM9831 allows a user to play back or insert silence (silent phrase). User can set up time length of silence from a minimum of 32ms to a maximum of 996ms in 32ms step when f_{OSC} =4.096 MHz. These time lengths are directly proportioned to the clock (f_{OSC}) period.

5. Phrase Control Table

Because the LSI contains the Phrase Control Table, it is possible to play back multiple phrases in succession by a single easy control operation like controlling a single regular phrase playback. Up to 8 combined phrases including a silence can be registered in a single address in the Phrase Control Table.

Further, you can use the maximum memory space for data storage because it is not required to have the same phrase data.

To show an example, let's assume that your application needs to speak two similar sentences, "It is fine today" and "It is rainy today." The two sentences have the common words "it", "is" and "today". What you have to do is to prepare these common sound data, not in sentences but in words, and to store each combined phrase data in Phrase Control Table as shown in Table 4.1 and Figure 4.1

Multiple phrases can be played continuously merely by specifying a desired phrase using an X address. For an example from Table 4.1, when address "01" is specified, "It is fine today" is played, and when address "02" is specified, "It is rainy" is played.

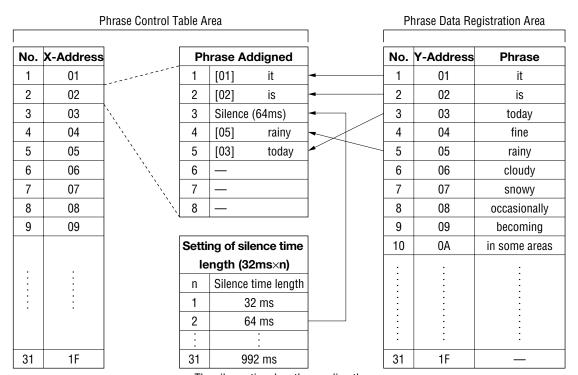
Phrase Control Table, a silence can be inserted without using the User's Area.

Minimum time for silence 32 ms
Maximum time for silence 992 ms
Time unit for setting up silence 32 ms

Table 4.1 Matrix of the Phrase Control Table

No.	X-Address (HEX)		Y-Address (Up to 8 phrases)							Sound Data
1	01	[01]	[02]	Silence		-		i i		It is (silence) fine today.
2	02	[01]	[02]	Silence	[05]	[03]	1	!		It is (silence) rainy today.
3	03	[01]	[02]	[04]	[09]	[06]	[05]	[0A]	[03]	It is fine becoming cloudy, rainy in some areas today.
:	÷		1	1	 	1	1	1	1	:
30	1E			1 1	 					
31	1F		1	1	 					

Figure 4.1 Phrase Combination Matrix for Phrase Control Table



The silence time lengths are directly proportional to the clock (f_{OSC}) period.

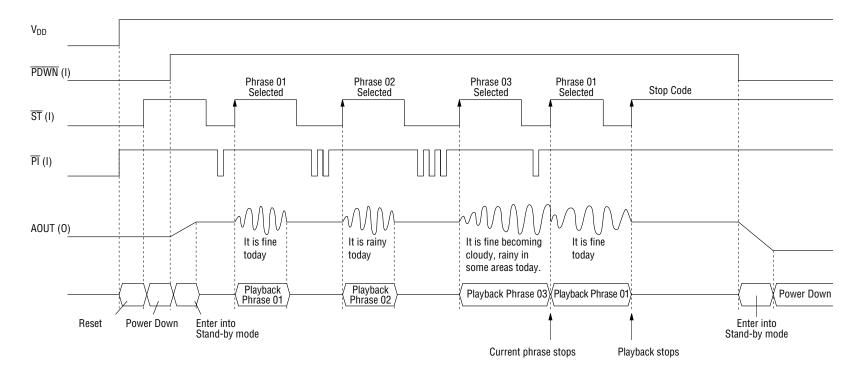


Figure 5.2 Playback timing when using phrase control data

6. Oscillation, Clock Signal Input

6-1 Using a Ceramic Oscillator

Figure 6.1 shows an oscillation circuit diagram using a Ceramic Oscillator. (Select Use a Ceramic Oscillator option on selecting options)

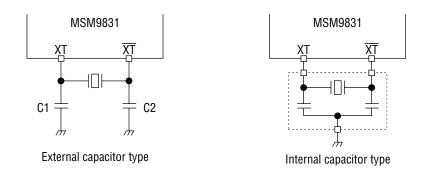


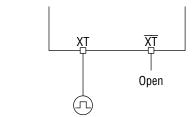
Figure 6.1 Oscillation Circuit with an external ceramic oscillator

The optimal load capacities when connecting ceramic oscillators from MURATA MFG., KYOCERA CORPORATION, and TDK CORPORATION are shown below for reference.

С	eramic oscillator		Optima capa	al load acity	Supply Voltage	Operating Temperature
Maker	Туре	Freq (MHz)	C ₁ (pF)	C ₂ (pF)	Range (V)	Rnage (°C)
MURATA MFG.	CSA4.00MG	4.0	30	30	3.0 to 5.5	-40 to +85
	CSA4.00MGW		Built in	Built in		
	CSAC4.00MGC		30	30		
	CSTCC4.00MG		Built in	Built in		
	CSA4.00MGU		30	30	2.7 to 5.5	
	CST4.00MGWU		Built in	Built in		
	CSAC4.00MGCU		30	30		
	CSTCC4.00MGU		Built in	Built in	2.6 to 5.5	
TDK	FCR4.0M5	4.0	33	33	2.5 to 5.5	-40 to +85
CORPORATION	FCR4.0MC5		Built in	Built in	2.5 to 5.5	
	CCR4.0MC3					
KYOCERA	KBR-4.0MSA	4.0	33	33	2.5 to 5.5	-20 to +80
CORPORATION	KBR-4.0MSB					
	KBR-4.0MKC		Built in	Built in		
	KBR-4.0MKD					
	KBR-4.0MKS		33	33		
	PBRC4.00A	1	Built in	Built in		
	PBRC4.00B	1	33	33		

6-2 Using External Clock Input

Figure 6.2 shows an oscillation circuit diagram using an external clock input.



External Clock, etc. as the timing source

Figure 6.2 Oscillation Circuit using an external clock input

7. Low-Pass Filter

In this IC, all voice outputs are through the built-in low-pass filter (LPF). Figure 7.1 and Table 7.1 show the LPF frequency characteristics and LPF cutoff frequency respectively.

The frequency characteristics and cutoff frequencies are directly proportional to sampling frequencies.

Only the voice output through LPF in this IC is enabled.

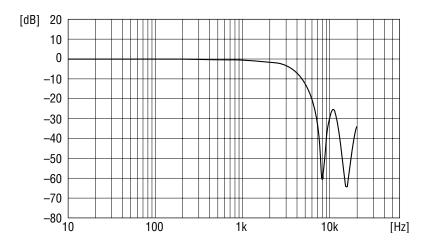


Figure 7.1 LPF Frequency Characteristics (f_{SAM}=8 kHz)

Sampling Frequency (kHz)	Cutoff Frequency (kHz)
(f _{SAM})	(f _{CUT})
4.0	1.2
5.3	1.6
6.4	2.0
8.0	2.5
10.6	3.2
12.8	4.0
16.0	5.0

Table 7.1 LPF Cutoff Frequency

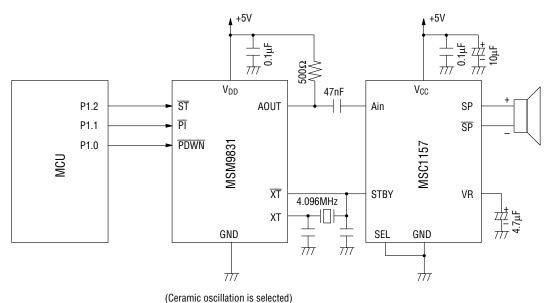
Connecting the MSM9831 to Speaker Driving Amplifier

The MSM9831 uses a current output type D/A converter.

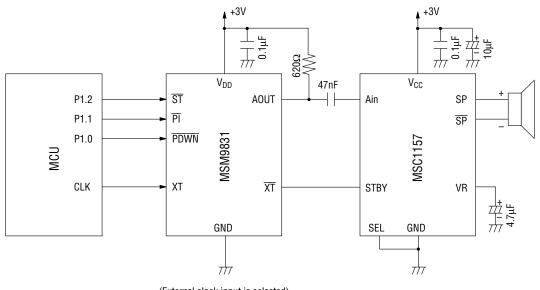
When the MSM9831 is connected to a voltage input type amplifier, it is required to convert the voice signal that is output as "change of current" into the voice signal that is output as "change of voltage".

The connection between the MSM9831 and MSC1157 (OKI speaker driving amplifier) when a resistor is used for the above conversion is described below.

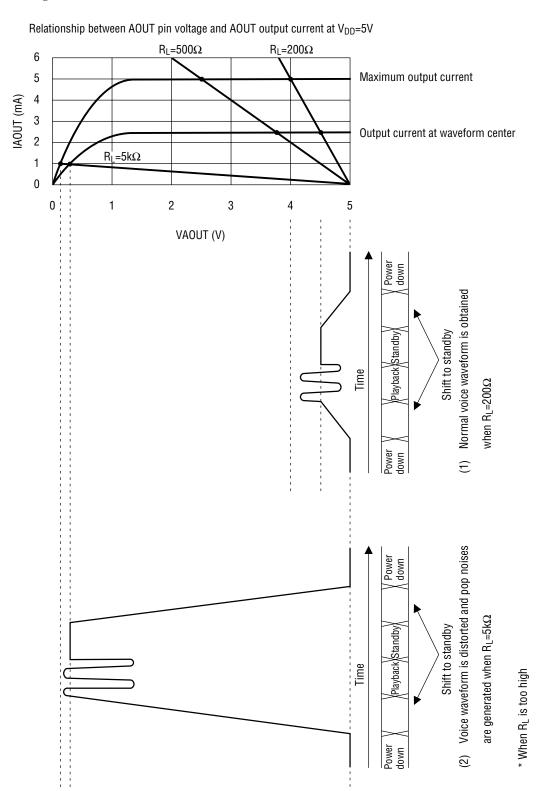
Circuit connection example 1: When V_{DD} =5.0V and the amplitude of Ain of the MSC1157 is $2.5V_{P-P}$



Circuit connection example 2: When V_{DD} =3.0V and the amplitude of Ain of the MSC1157 is $1.5V_{P-P}$

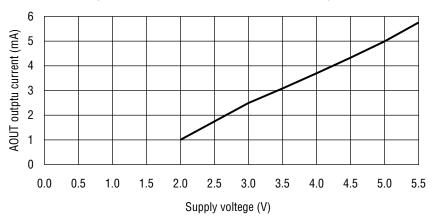


Use a resistor with an appropriate value (R_L) considering the output voltage (reference the drawing below).

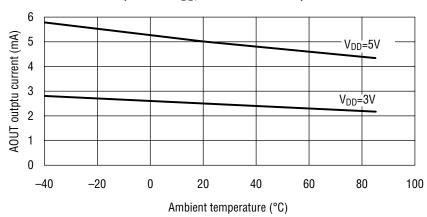


D/A CONVERTER OUTPUT CURRENT

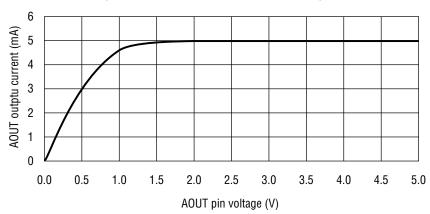
Relationship between supply voltage and AOUT output current (Ta=25°C, VAOUT=V_{DD}, PCM at maximum)



Relationship between ambient temperature and AOUT output current (VAOUT=V_{DD}, PCM at maximum)



Relationship between AOUT pin voltage and AOUT output current (Ta=25°C, V_{DD}=5.0V, PCM at maximum)



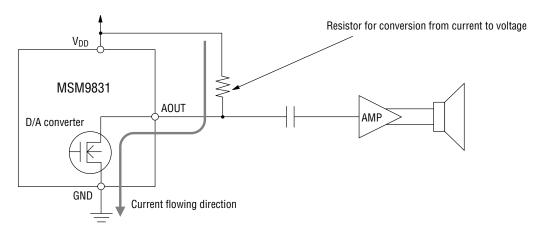
NOTES

1. Internal converter circuit

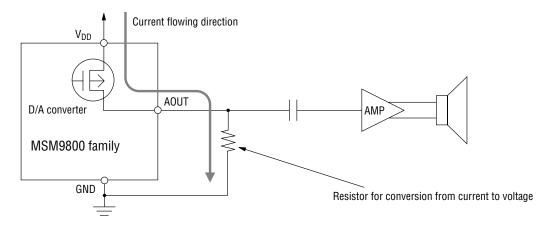
The MSM9831 has not employed a voltage output type D/A converter but a current output type D/A converter. Therefore, the voice output circuit of the MSM9831 is different from that of the MSM6650 family product which has employed a voltage output type D/A converter. The voice output circuit of the MSM9831 also is different from that of the MSM9800 family product because the MSM9831 has employed a current flowing-in type D/A converter and the MSM9800 family product has employed a current flowing-out type D/A converter. (See the table below)

Product name	D/A converter output circuit	
MSM6650 family	Voltage output type	
MSM9800 family	Current output (flowing-out) type	P-MOS open drain
MSM9831	Current output (flowing-in) type	N-MOS open drain

Circuit connection between the MSM9831 and amplifier IC



Circuit connection between the MSM9800 family product and amplifier IC

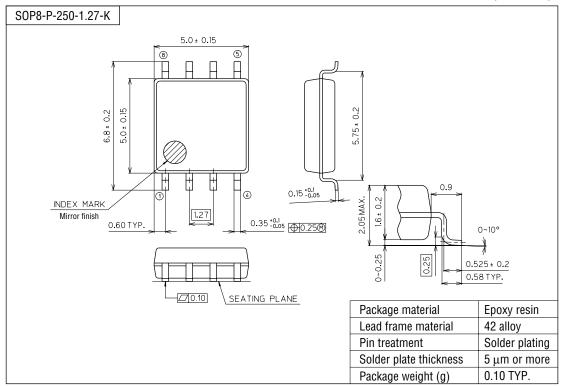


2. Ceramic oscillator

A crystal that is usable in this LSI is described in "Functional Description" of this document. If you want to use another crystal, it is recommended to evaluate the crystal before using it.

PACKAGE DIMENSIONS

(Unit: mm)



Notes for Mounting the Surface Mount Type Package

The SOP, QFP, TSOP, TQFP, LQFP, SOJ, QFJ (PLCC), SHP, and BGA are surface mount type packages, which are very susceptible to heat in reflow mounting and humidity absorbed in storage. Therefore, before you perform reflow mounting, contact Oki's responsible sales person on the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

NOTICE

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- 2. The outline of action and examples for application circuits described herein have been chosen as an explanation for the standard action and performance of the product. When planning to use the product, please ensure that the external conditions are reflected in the actual circuit, assembly, and program designs.
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